Product data sheet

1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO247 plastic package, designed for high frequency switched-mode power supplies.





2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I_{FSM}
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{j(max)} = 175 °C)

3. Applications

- · Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit			
Absolute maximum rating									
V_{RRM}	repetitive peak reverse voltage		1200			V			
I _{O(AV)}	limiting average output current	$δ = 0.5$; $T_{mb} \le 147$ °C; square-wave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3; Fig. 4	10		A				
T _j	junction temperature		175			°C			
Symbol	Parameter	Conditions	Min Typ Max		Max	Unit			
Static ch	aracteristics								
V _F	forward voltage	I _F = 5 A; T _j = 25 °C; per diode; <u>Fig. 6</u>		-	1.4	1.6	V		
		I _F = 5 A; T _j = 150 °C; per diode; <u>Fig. 6</u>		-	1.85	2.3	V		
I _F = 5 A; T _j = 175 °C		I _F = 5 A; T _j = 175 °C; per diode; <u>Fig. 6</u>		-	2	2.6	V		
Dynamic	Dynamic characteristics								
Q _r	recovered charge	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; per diode; Fig. 8$		-	12	-	nC		

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode		
2	K	cathode	Т 004	A1
3	A2	anode		K
mb	К	mounting base; connected to cathode		sym125

6. Ordering information

Table 3. Ordering information

Type number	Package	Orderable part number	Packing	Small packing	Package	Package
	name		method	quantity	version	issue date
WNSC101200CW	TO247	WNSC101200CWQ	Tube	30	TO247N	20-Jul-2016

7. Marking

Table 4. Marking codes

Type number	Marking codes
WNSC101200CW	WNSC101200CW

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		1200	V
V_{RWM}	crest working reverse voltage		1200	V
V_R	reverse voltage	DC	1200	V
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_{mb} \le 147 °C$; square-wave pulse; per diode	10	Α
I _{O(AV)}	limiting average output current	δ = 0.5 ; $T_{mb} \le$ 144 °C; square-wave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3; Fig. 4	10	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	65	А
		t_p = 10 µs; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	525	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms; per diode	21	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C

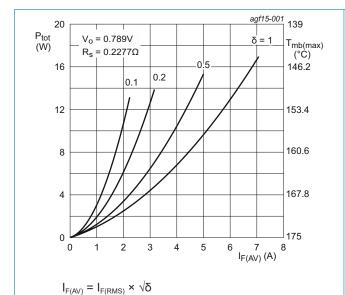


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; typical values; per diode

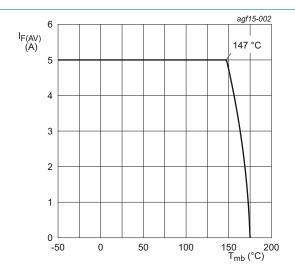
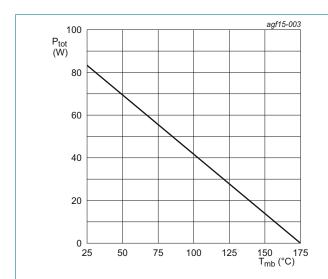


Fig. 2. Forward current as a function of mounting base temperature; typical values; per diode





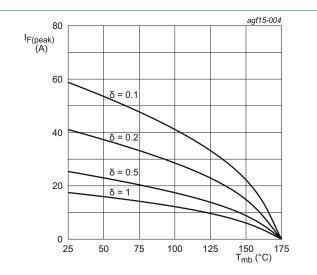


Fig. 4. Current derating as a function of mounting base temperature; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance	per diode; Fig. 5	-	-	1.8	K/W
	from junction to mounting base	both diodes conducting	-	-	1	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	40	-	K/W

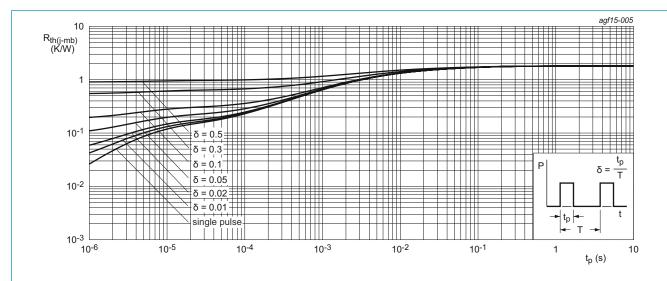
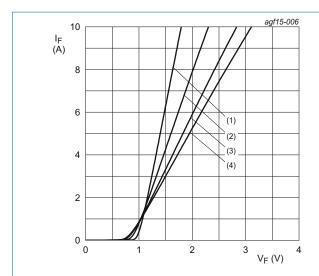


Fig. 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions M		Min	Тур	Max	Unit
Static cha	racteristics						
V_{F}	forward current	$I_F = 5 \text{ A}; T_j = 25 \text{ °C}; \text{ per diode}; Fig. 6$		-	1.4	1.6	V
		I _F = 5 A; T _j = 150 °C; per diode; <u>Fig. 6</u>		-	1.85	2.3	V
		I _F = 5 A; T _j = 175 °C; per diode; <u>Fig. 6</u>		-	2	2.6	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; per diode; <u>Fig. 7</u>		-	4	50	μA
		V _R = 1200 V; T _j = 175 °C; per diode; <u>Fig. 7</u>		-	150	-	μA
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 5 \text{ A}$; $V_R = 400 \text{ V}$; $dI_F/dt = 500 \text{ A}/\mu\text{s}$; $T_j = 25 \text{ °C}$; per diode; Fig. 8		-	12	-	nC
C _d diode capacitance		f = 1 MHz; V _R = 1 V; T _j = 25 °C		-	250	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C		-	24.5	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C		-	22	-	pF



(1) T_j = 25 °C; typical values (2) T_j = 100 °C; typical values

(3) T_i = 150 °C; typical values

(4) T_i = 175 °C; typical values Fig. 6. Forward current as a function of forward

voltage; typical values; per diode

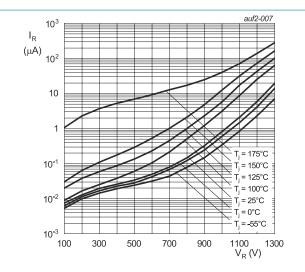
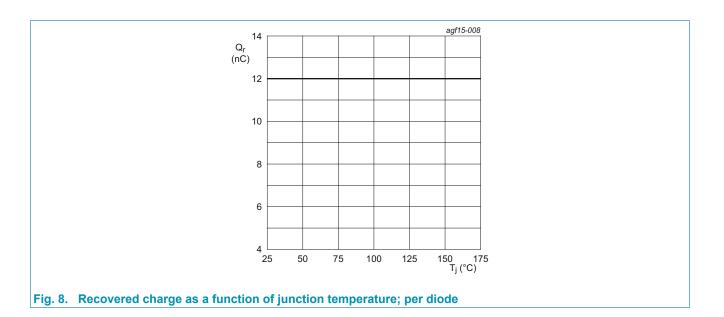
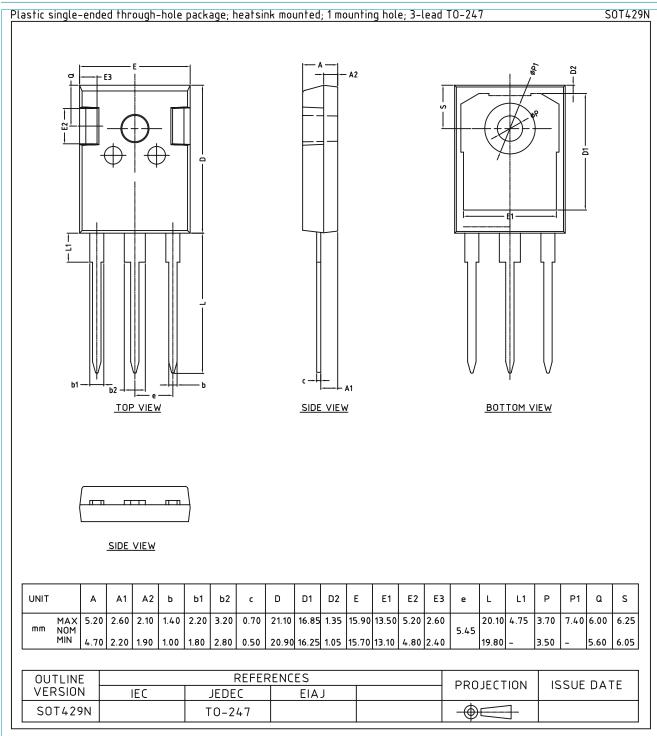


Fig. 7. Reverse leakage current as a function of reverse voltage; typical value; per diode



11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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	Features and benefits

For more information, please visit: http://www.ween-semi.com For sales office addresses, please send an email to: salesaddresses@ween-semi.com Date of release: 04 December 2019

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